ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES	Bannockburn,	Illinois. All rights reserved u	nder both le	his docume vel parts, t	ent is a declaration he declaration en	n of the substance compasses all low	es within the manufactur ver level materials for wl	er listed item. No	ote: if the item is an cturer has engineerin	assembly with lower g responsibility.		
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distrib			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				als and Mfg Information				
Supplier Information												
Company name* Company unique ID				Unique ID Authority			Response Date*					
semi									2025-06-09			
Contact Name	Title - Contact]	Phone - Contact*				Email - Contact*			
Product-Env-Stewards	duct-Env-Stewards Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards	oduct Enviro Compliance	t Enviro Compliance		NA			Product-Env-Stewards@onsemi.com					
Requester Item Number	nber Mfr Item Number		nber Mfr Item Name		Effective Date	Version	Manufacturing Site	Weight	t* UOM	Unit Type		
	NUP5120X67	T1G ZENER PENTA	ARRAY IN SOT-		2025-06-09		CN1	2.7	mg	Each		
Manufacturing Proccess Information					•				·	·		
Terminal Plating / Grid Array Materia	ial Terminal Base Alloy		J-STD-020 MSL R	Rating	Peak Process Body Temperature		ture Max Time at Peak	Temperature N	Number of Reflow C	ycles		
Matte Tin (Sn) - annealed CU Alloy 1		1		260	С	30	seconds 3	3				
Comments												
level 1 - maximum time at peak temperature d	uring solderi	ing is 10-30 seconds										
For more information regarding material com	position pleas	se refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-	_		-
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.01	mg	Supplier	Silicon (Si)	7440-21-3		0.01	mg
Lead Frame 1.	1.19	mg	В	Nickel (Ni)	7440-02-0		0.482	mg
			Supplier	Iron (Fe)	7439-89-6		0.6605	mg
			Supplier	Copper (Cu)	7440-50-8		0.0476	mg
Mold Compound-Black	1.4	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.14	mg
			Supplier	Carbon Black (C)	1333-86-4		0.007	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.203	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.91	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.14	mg
Plating	0.06	mg	Supplier	Tin (Sn)	7440-31-5		0.06	mg
Wire Bond - Cu	0.04	mg	Supplier	Copper (Cu)	7440-50-8		0.04	mg